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3D Printed Vision-Based Micro-Force Sensors for Microrobotic Applications

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Abstract

Over the years, research and development into micro-force sensing techniques has gained a lot of traction, especially for microrobotic applications, such as micromanipulation and biomedical material characterization studies. Moreover, in recent years, new microfabrication techniques have been developed, such as two-photon polymerization (2PP), which enables fast prototyping, high resolution features, and the utilization of a wide range of materials. In this work, these two fields are combined to realize the first fully 3D printed vision-based micro-force sensor. The sensor exhibits tunable stiffness properties, which are simulated and compared with calibration values for a variety of 2PP printing settings. Furthermore, a novel bimaterial printing approach was utilized to fabricate sensors with a highly compliant sensing structure and rigid body. Lastly, the sensors are used to measure the mechanical properties of fish eggs as a cell analog to showcase the possible applications of the system.

Keywords: Microrobotics, Vision-Based Force Sensors, Two-Photon Polymerization, Micromanipulation

1 Introduction

Micromanipulation can be defined as the controlled handling of microstructures ranging in size from a few to hundreds of micrometers, consisting of a very broad and promising field within the microtechnologies world. With the ever growing minituarization demand for electromechanical systems, the necessity of a high precision and robust system to manipulate and assemble such devices has emerged. Furthermore, the growth of the biomedical field and studies of the effects of forces on cells and tissues (mechanobiology) also contributes to an increasing demand for such a system. For these application scenarios, the micromanipulation field emerged, gaining more traction and many systems were developed. In general, micromanipulation systems can be divided into two categories: tethered and untethered. The main difference between these two is related to the accuracy of the system. Untethered systems are dependent on field-driven actuation [1–3]. Therefore, having precise position control can be challenging. However, tethered systems typically provide more accurate position control through motor actuator feedback and thus more accurate micromanipulation [4, 5]. One drawback of tethered systems is that they can be hard to miniaturize and the size of end-effectors tend to dominate the system field of view, reducing the practical workspace area. Here, work on developing miniaturized micro-force sensing end-effectors for a tethered micromanipulation system is developed to overcome this limitation.

When dealing with manipulation at small scales, surface and contact forces become extremely important and nonintuitive. Therefore, the micromanipulation system’s ability to sense its environment is crucial for the development of the field and it enables more complex and accurate applications. While the manipulation of rigid micro-objects does not require micro-force sensing, such capabilities allow for the development of closed-loop systems with much higher accuracy, repeatability, and throughput. Furthermore, the use of micromanipulation systems for biomedical applications require micro-force sensing since the objects being studied (single cells, tissues, etc.) are fragile and can be easily damaged if too high manipulation forces are applied. Lastly, many applications also require the input of specific micro-forces in order to study the biological response of such forces, such as the field of mechanobiology [6–8], and for mechanical characterization studies [9, 10].

In the past, many micro-force sensing techniques and modalities for micromanipulation have been explored, such as piezoelectric/piezoresistive [11–13], capacitive-based [14], AFM-based methods [15, 16], vision-based [17–19], strain gauges [20, 21], among others. For this study, a vision-based micro-force sensor is developed for its simplicity in design that can be scaled down and directly 3D printed with tailored stiffness values. It also overcomes many of the drawbacks of the other types of micro-force sensors, such as high costs and difficult integration into micromanipulation systems (AFM-based sensors), non-linear sensor requiring multiple calibrations (strain gauges), temperature and humidity sensitivity (capacitive-based sensors). Vision-based micro-force sensors are purely mechanical, compliant structures with calibrated stiffness values, thus

they do not require any electronics or signal conditioning. For the micro-force ranges for which they are used, they can function under the Hooke's law principle so that when a force is applied to the end of the sensor, the measured deflection of the structure is directly correlated to the applied force.

Traditionally, vision-based micro-force sensors have been fabricated using standard 2D microfabrication techniques, such as photolithography and etching, micromolding, or other methods to pattern a soft material [17, 22, 23]. However, with the development of fast lasers (femtosecond repetition rate), new 3D fabrication systems based on Two-Photon Polymerization (2PP or TPP) have been developed, enabling fast prototyping, with complex 3D geometries and a multitude of material options (including soft resins and responsive materials), while simultaneously achieving sub-micrometer resolution and structures ranging in size from a few microns to a few millimeters. This powerful micro-fabrication technique requires a study of the optimal printing settings and geometries for specific designs. Oftentimes, a parametric sweep is required to print complex 3D shapes, such as undercuts and small structures. The attachment to the substrate must also be considered: large contact areas with the substrate can result in difficulties releasing the part post-print, and low contact areas can result in premature release during the printing process. Additionally, the mechanical properties of the resultant structures are often unknown due to the high number of print settings and inherent viscoelastic behavior presented by certain resins, especially softer ones. In this paper, the first fully 3D printed vision-based micro-force sensor is developed and characterized. The design is tuned for the 2PP printing capabilities and available materials. With the use of simulations and calibrated sensors, the stiffness of the resultant sensors are compared. Subsequently, this sensor is utilized to characterize the mechanical properties of fish eggs, as cell analogs. Moreover, a bimaterial printing approach is employed to successfully fabricate and release from the substrate a low-stiffness sensor capable of nN force measurement.

2 Vision-based Force Sensor Design

A vision-based force sensor is a device that consists of a pre-calibrated compliant structure of known stiffness (k) and a vision system that is able to track deflections (Δx). When a force is applied to the sensor, a measurable deflection can be tracked and the principle of Hooke's law is used to compute the applied force ($F = k \cdot \Delta x$). In the past, vision-based micro-force sensors were created using standard microfabrication techniques, such as multiple photolithography steps followed by deep etching and polymer deposition. These multi-step processes require a lot of time and are limited to fabricating monolithic 2D structures. Furthermore, they require multiple masks to create the geometry patterns, making it difficult and time-consuming to iterate on the design, if needed. Additionally, their geometric complexity and material also limited the scaling down of the critical dimensions of the compliant structure in the sensor. Conversely, using 2PP fabrication, complex 3D shapes are attainable for

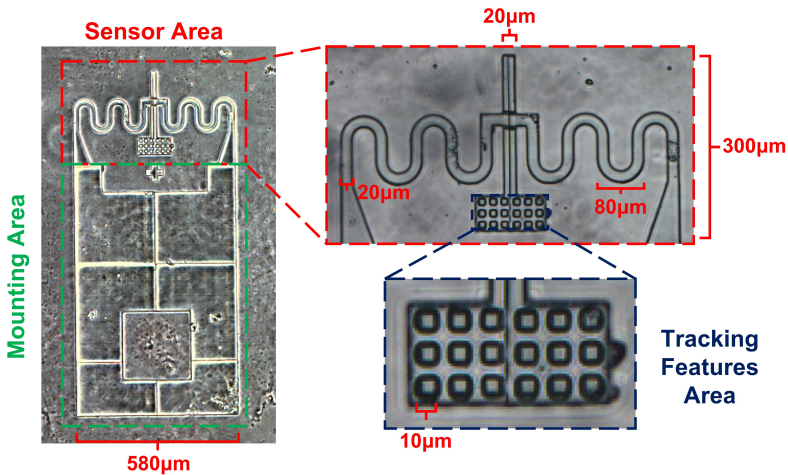


Fig. 1: Overview of the sensor design with critical dimensions annotated. The lines running through the design correspond to the stitching of the 400 μm blocks. The rectangular pattern on the bottom right part of the figure represents the computer vision tracking markers.

a wide range of materials. The printing resolution can reach the range of hundreds of nanometers and different designs can be prototyped with just changes to a CAD file. Also, the size of the structures to be printed can easily be scaled down in size.

Taking inspiration from our previous design of a vision-based micro-force sensor (μVBFS) [18, 19], a similar sensor design was fabricated here using the 2PP principles, taking advantage of the capabilities mentioned earlier. Figure 1 shows a schematic of the overall sensor design with its rigid body and compliant spring-like structure, along with critical dimensions. With the advantages of the 2PP fabrication method, different designs can be quickly printed and tested, including different end-effectors or the use of different print settings to create sensors with different mechanical properties. Furthermore, squared markers were added to the back part of the compliant structure. They are used to make it easier for the computer vision algorithms to locate and track the deflections of the compliant spring, thus resulting in a more robust and accurate micro-force sensor. These markers are shown in the tracking feature area region of Fig. 1. Lastly, due to the easy prototyping provided by 2PP fabrication, a mounting hole has been added to the back of the design for easier assembly onto a micromanipulator probe. This is shown in the mounting area of Fig. 1. When comparing to the previous generation of vision-based force sensors, 2PP microfabrication enabled the minituarization of the overall sensing area footprint by approximately 38%, the addition of more complex geometrical features, and the higher versatility of printing settings.

For the sensors fabricated in this work, the Nanoscribe Photonic Professional GT2 printer (Nanoscribe GmbH & Co.), which uses a Near-Infrared (NIR) femtosecond laser was utilized. Based on the overall dimensions of the sensor, the 25x objective lens is the most promising solution using this printer. This objective lens also provides a larger variety of printing resins. In this work, printing with IP-S and IP-PDMS was explored. IP-S utilizes a more standard and well studied recipe, providing more accurate results, easy removal from substrate but at the cost of a higher stiffness structure. On the other hand, IP-PDMS is a newer resin that is able to provide much lower stiffness results, but much more needs to be studied regarding optimized print settings and substrate release techniques.

At first, single material IP-S sensors were printed and their stiffness characterized and compared to simulation values based on the manufacturer's specifications, as further described in Section 4.1. Three types of IP-S sensor designs were studied, each using a different fabrication setting in order to better understand how these settings affect the overall structure stiffness. The main difference between these sensors lie in their fill settings for the compliant part of the design. By simply changing the fill settings, the three different sensors can be produced from the same CAD file. The compliant springs either have solid cross-sections (Type 1), triangular scaffolding (Type 2), or hollow cross-sections (Type 3), as shown in Fig. 2 (a-c). Furthermore, one of the major issues with 2PP fabrication is the release of fragile structures from the substrate without breaking them. To solve this issue, the compliant structure was designed with a trapezoidal base, which effectively reduces the contact area with the substrate by half, as shown in Fig. 2 (d). *In the case shown, the trapezoidal region has a height of a quarter of the total spring thickness, and the width goes from the total width of the spring to half of it at the interface with the substrate.*

3 Sensor Fabrication

Two-photon polymerization, referred to here as 2PP, is a recent innovation in the micro/nano-fabrication field that allows the 3D printing of small scale structures with high accuracy and the ability to produce complex 3D geometries. Moreover, it has a high range of possible fabrication materials, which enables the development of tailored structures with different mechanical properties and even the fabrication of active structures, commonly called 4D printing. This method is based on the two-photon absorption principle, in which an atom is able to absorb two photons and go to a higher energy state in which the radicals are locally excited and they crosslink within the photoresin causing polymerization. This process is governed by a very brief virtual state, thus the need to use lasers with high repetition rates (around the femtosecond range). Additionally, the crosslinking process decays in the order of distance squared, enabling the polymerization of just a small region, resulting in high resolution fabrication.

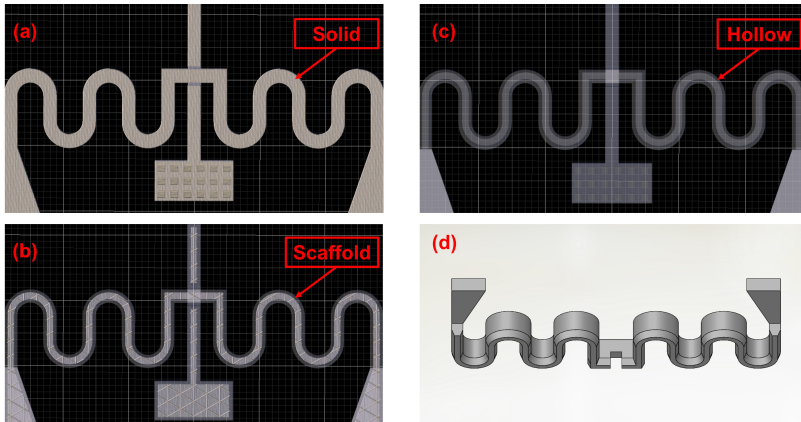


Fig. 2: Different fill settings and complex 3D geometries made possible by 2PP fabrications for a single material design: (a) solid spring (Type 1), (b) triangular scaffold spring (Type 2), (c) hollow spring (Type 3). (d) Trapezoidal spring base for easier substrate release.

For each of the three different types of IP-S designs, the laser power and scan speed were kept constant at 100% and 100,000 $\mu\text{m}/\text{s}$ (or 100 mm/s), respectively, since these values were known to produce good results with IP-S prints. Using these settings, the sensors were fabricated using the 25x (NA 0.8) lens in a Dip-in Laser Lithography (DiLL) configuration with ITO-coated sodalime glass substrates (indium-tin oxide). These substrates are used with this configuration to increase the adhesion forces to keep the structure from being released prematurely. Using this configuration, the highest resolution attainable is in the order of 2 μm with printing field of 400 $\mu\text{m} \times 400 \mu\text{m}$. Since the overall structure is larger than the printing field, the sensor is constructed by splitting the design into smaller blocks that are stitched together. Figure 1 shows the lines where the sensor is stitched together to create the the mounting area region and connect it to the sensor area region of the device.

Initially, a sensor made entirely out of IP-PDMS was investigated. For these sensors, multiple fabrication settings had to be optimized in order to develop a usable sensor. When using IP-PDMS, adhesion to the substrate is a significant issue: if not properly polymerized, the structure can peel-off the substrate and be released prematurely during the printing process. Conversely, due to its soft nature, it can be increasingly difficult to release the structure post printing. Additionally, it was observed that the print resolution with IP-PDMS is much lower when compared to IP-S, somewhere around 8 μm . By increasing the laser power during the print process, it was found that the structures were more likely to remain attached to the substrate, but localized heating of the resin was more prominent. This leads to the formation of bubbles and the ruining the printed structure. After some optimizing, a balance was struck and the

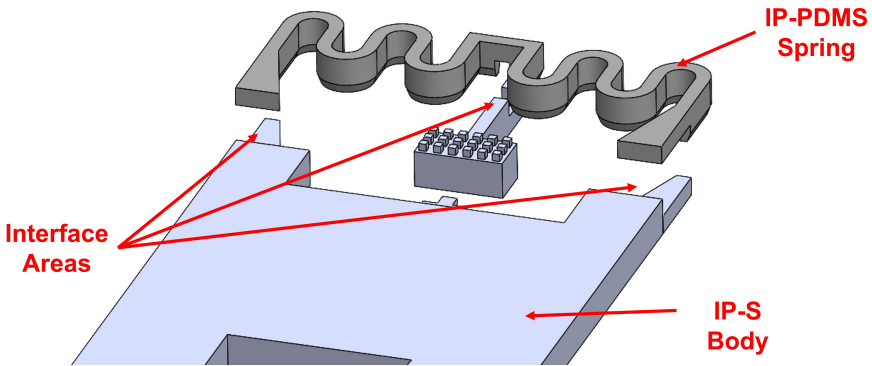


Fig. 3: Exploded view schematic of the bimaterial sensor design showing the IP-PDMS spring, IP-S body, and the interface locations between the two materials. Note that at these interface locations the thickness of the IP-S and IP-PDMS sections are each half of the total thickness.

IP-PDMS structures were printed using a laser power and scan speed of 80% and 100,000 $\mu\text{m/s}$ (or 80 mm/s), respectively.

These print settings led to the successful fabrication of IP-PDMS sensors, however, due to their large surface area, it was not possible to release them from the substrate without damaging the compliant structure. Due to this, a new bimaterial printing approach was used: printing the sensor's body and end-effector with the rigid IP-S resin, and the compliant sensing structure with the soft IP-PDMS resin, as shown schematically in Fig 3. To do this, the rigid structures are printed and developed first, then the IP-PDMS spring is manually aligned and printed with a solid cross-section on the sensor. The sensor was designed in such a way that there is enough contact area between the IP-S and IP-PDMS parts to ensure good adhesion. Even with these changes, the release of the IP-PDMS spring still proved to be a challenge. Therefore, taking inspiration from previous works [24, 25], a Dextran sacrificial layer was added to aid the release of the sensors. This sacrificial layer (Dextran 70, 20 wt% solution with DI water) was spin-coated onto the glass slide at 1000 rpm for 1 min prior to fabrication. Then, once the entire sensor was fabricated and the excess resin removed, a water bath was used to strip the Dextran layer, helping with the sensor release. Moreover, a micromanipulator system with a sharp probe was used to carefully release the sensor from the substrate.

4 Simulations and Characterization

4.1 FEA Simulations

In order to accurately sense micro-forces, the spring structure of the device must be designed with low stiffness in each of the planar (XY) 2D sensing

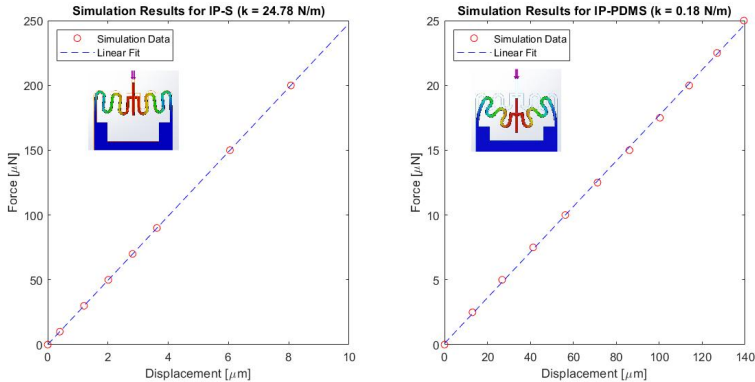


Fig. 4: FEA analysis of the stiffness of the spring-like compliant structure of the sensor. Plot shows the data acquired from the simulation and the linear fit to compute the stiffness. Simulations shown for both IP-S (left) and IP-PDMS (right) compliant structures.

dimensions. This stiffness is a function of the spring geometry and material property of the structure itself. While the 2PP system produces a very accurate replication of the designed geometry in the produced prototypes, the material properties given by the resin’s manufacturer only apply to the standard print settings. Thus, any deviation from these print settings may result in different material properties and thus different device stiffness.

Using the material properties provided by the resin’s manufacturer for IP-S ($E = 5.11$ GPa, $\nu = 0.3$), a finite element analysis (FEA) of the Type 1 design spring structure was compiled. For the simulations, the sensor body was fixed and a load was applied directly to the end-effector. The slope of the linear fit from the force versus displacement plot corresponds to the sensor stiffness in the direction (Y-axis) of the applied force. For this base design with standard material properties, the stiffness is $k = 24.78$ N/m. Using the same simulation settings and sensor geometry, a stiffness simulation was also performed for a sensor with an IP-PDMS ($E = 15.3$ MPa), compliant sensing structure. For this material choice, the computed stiffness is $k = 0.18$ N/m. The simulation results for both sensor materials are shown in Fig. 4

The sensing resolution of a vision-based sensor is given by the directional stiffness of the compliant structure and the spacial resolution of the camera system utilized, i.e., the actual distance each pixel represents in the camera frame. Therefore, there is a trade-off between the overall size of the workspace and the force sensing resolution of the system. For the sensor calibration, a higher resolution camera is used to achieve the most accurate characterization, however, for practical uses, a camera with a larger workspace view and thus smaller spacial resolution is used.

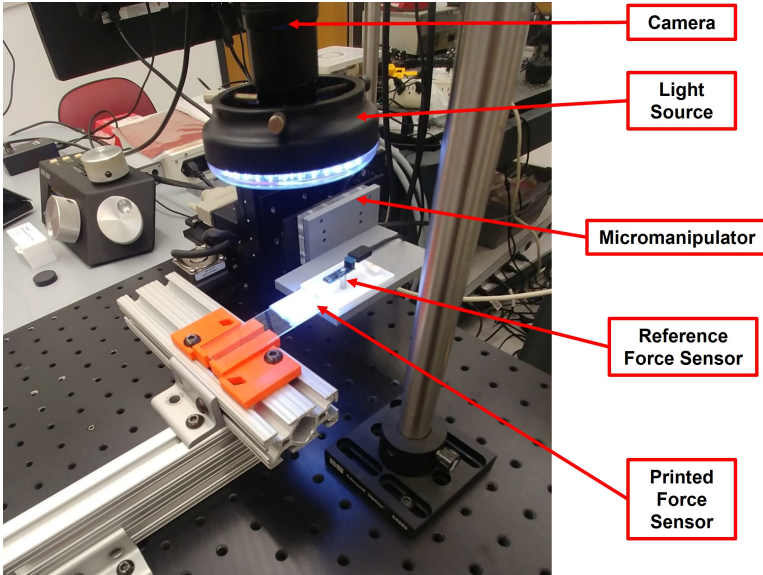


Fig. 5: Calibration setup using a micromanipulator (MP-225, Sutter Instruments), camera system (Flea3, PointGrey), and reference force sensor (FT-S100, Femto Tools).

4.2 Mechanical Characterization

In order to compute the true stiffness of the different printed sensors, an experimental setup with a micromanipulator, camera, and mount was developed, as shown in Fig. 5. Here, a reference force sensor (Femto Tools FT-S100) is attached to a micromanipulation system (MP-225, Sutter Instruments), and is pushed against the printed force sensor to be calibrated, which is fixed at one end of a glass slide. The micromanipulator then records its displacement, moving at $1\mu\text{m}$ increments at a time. Therefore, by slowly increasing the displacement, a force versus displacement plot can be presented for the printed sensor, thus calibrating its stiffness. Figure 6(a) shows the loading profile (force over time), from where the data is extracted to create the force versus displacement plot, as shown in Fig.6(b), for a representative Type 1 prototype. This is done for both the loading and unloading portion of the characterization, resulting in two lines that should theoretically have the same stiffness. This same process is repeated 3 times using the same sensor to achieve an accurate measure of its stiffness. **Here, the initial position for the loading portion is set at an unloaded state of the spring, whereas the initial position of the unloading part takes place at the maximum force experienced. Therefore, the two slope lines have opposite signs, but similar magnitudes, as expected.**

From the loading profile shown in Fig. 6(a), it can be seen that the forces change slightly as time goes on for the same micromanipulator deflection. Some of the noise can be attributed to the reference sensor's sensitivity, which

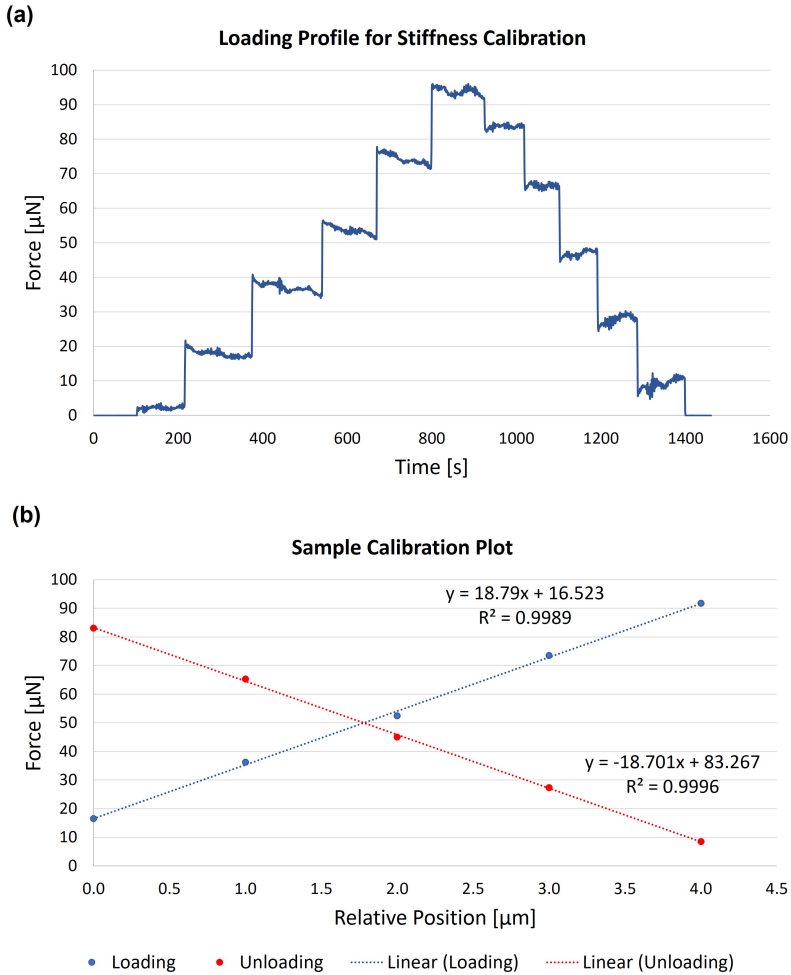


Fig. 6: (a) Loading and unloading profile for the stiffness characterization of Type 1b μVBFS . (b) Sample calibration plot extracting the force values from the loading profile and deflections from the micromanipulator motion. The slope of the two lines indicate the stiffness results when analyzing the loading and unloading of the force sensor.

is highly affected by any vibrations in the room, including the motion of the stepper motors in the micromanipulator system. Furthermore, the changes in force can also be attributed to the viscoelastic behavior of the printing material. According to its datasheet, IP-S has a storage modulus of 5.33 GPa and a loss modulus of 0.26 GPa, resulting in a small loss tangent value, which indicates almost no phase lag between stress and strain. As expected, the behavior of the sensor during the calibration follows that of a material with small viscoelastic behavior.

Since 2PP is a relatively new fabrication technique, there are many questions that remain unanswered regarding its performance and expected results. Firstly, how do the material properties of the printed sensors relate to the simulation values obtained by using the nominal material properties of the resin? Additionally, how do these results compare when two sensors are printed using different 2PP machines? To answer these questions, 4 different sensors were calibrated using the experimental setup described above and the results compared, as shown in Table 1. Each sensor was calibrated 3 times for more accurate results. Note: sensors Type 1a and Type 1b are both made out of solid IP-S, but Type 1a was made using a GT+ system in France (FEMTO-ST) and Type 1b was fabricated using a GT2 system in the United States (Purdue University). Type 2 and Type 3 sensors were fabricated with the triangular mesh and hollow spring designs, respectively, as previously described. Type 4 sensors are the bimaterial designs with the IP-PDMS compliant sensing structure and solid cross-section. Table 1 also shows the relative error in the calibration of each sensor type in the form of standard deviations. This is expected, given that a purely linear behavior is assumed. However, the material is not perfectly elastic. Nevertheless, error propagation calculations show that this deviation contributes very little to the overall error in force measurement values.

Based on the calibration results, it is clear that the stiffness of the Type 1 solid sensors match regardless of the equipment that was used. Interestingly enough, the Type 2 design with the triangular scaffolding on the inside has the same stiffness as the solid Type 1 IP-S designs. It seems that the amount of trusses on the inside of the structure make up for the lack of material and keep the same overall stiffness. This can be used as a more optimal printing parameter for the sensor, since it not only has the same stiffness, but also prints the structure 3 times as fast, resulting in higher throughput without compromising the structural integrity of the design. As expected, the Type 3 hollow design has a smaller stiffness than Type 1 and 2 designs. This shows that the printing properties can have a large impact on the resultant stiffness, and along with geometry changes, can lead to specifically tailored sensors based on the target application. Comparing the calibrated stiffness of the solid sensors (Type 1a and 1b) to the simulation results in Fig. 4, they are in the same order of magnitude, but not exactly the same. As mentioned before, the discrepancy in the values can be caused by many factors since the stiffness is highly dependent on printing parameters. Interestingly enough, the same small discrepancy was observed when comparing the simulated and calibrated stiffness of the IP-PDMS sensors. The physical sensor presented a slightly lower stiffness, but the simulated value was within a similar range. In general, simulations are useful to obtain an approximate value for the stiffness, however each sensor must still be calibrated individually before use for higher accuracy in the force sensing.

Based on these results, it is clear that it is possible to fabricate a vision-based micro-force sensor solely using 3D printing techniques. However the device stiffness is still larger than previous generations of the system [18].

Table 1: Stiffness calibration for different 2PP printed sensor types along with standard deviation (St. Dev.)

Sensor	Description	Stiffness (N/m)	St. Dev.
Type 1a	Solid IP-S made in France	18.23	0.18
Type 1b	Solid IP-S made in the US	18.56	0.81
Type 2	IP-S w/ triangular scaffold	18.03	0.94
Type 3	Hollow IP-S	7.27	0.92
Type 4	Bimaterial w/ IP-PDMS spring	0.08	0.0004

Table 2: Comparison between different generations of vision-based force sensors developed in previous works and the current 3D printed solution. The first sensor on the table refers to the one developed in [18], while the other two represent the sensors studied here.

Fabrication Method	Spring Material	Stiffness (N/m)	Resolution*	Range* (μ N)	Sensing Area Footprint (μ m)	Fabrication Time
Photolithography	PDMS	~ 0.4	Low μ N	~ 50	800 x 300	Few Days
2PP	IP-S	~ 18	High μ N	~ 1500	500 x 300	~ 20 min
2PP	IP-PDMS	~ 0.08	High nN	~ 10	500 x 300	~ 40 min

* Note: The range and resolution values dependent on the camera resolution and zoom level of the vision system. A vision system with a 1.6 pixel/ μ m ratio is assumed here.

This is largely due to the material selection. Thus the ability to fabricate a sensor with softer materials, namely IP-PDMS, would be ideal. Using the same calibration setup and procedure, the printed bimaterial sensors with IP-PDMS springs (Type 4), had their stiffness characterized. As expected, the overall stiffness is much lower than the IP-S sensors, resulting in a much higher force resolution, enabling it to be used for lower force applications.

Comparing the sensors developed in this work with their previous generation, which was fabricated using photolithography and had a rigid silicon body with a PDMS spring, the design trends seem promising: the fabrication times have been decreased, smaller sensor footprints obtained, higher versatility of materials available, and higher resolution of the sensor produced. Table 2 shows a general picture of the last generation sensor and the newer sensors developed, both the fully IP-S version and the bimaterial approach with IP-PDMS compliant structure.

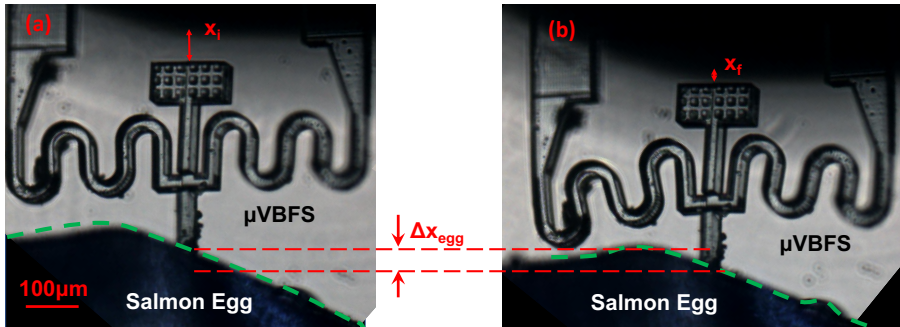


Fig. 7: Camera view of the stiffness characterization of a salmon egg (outlined in green) using the μ VBFS. (a) shows the initial position (undeflected state) and (b) shows the final position (under load).

5 Force Sensing Applications

One of the many possible applications for the sensor developed in this work is the characterization of the mechanical properties of biological media, such as cells, tissues, proteins, etc. To showcase the μ VBFS capabilities, the sensor was utilized to measure the stiffness of approximately 2 mm diameter salmon eggs, used here as larger scale cell analog. For this experiment, the force sensor was attached to the end of a micromanipulator probe [18, 19] so it can be precisely guided to the egg outer wall and then perform controlled force exertion for the characterization. The egg itself is secured to a glass slide substrate to prevent it from sliding and making sure all the applied force translates into outer wall deflection. Then, all the components are mounted under a camera system to record the relative deflections of the μ VBFS and the egg's outer wall.

This system can be modelled as two springs in series with stiffness k_{sensor} and k_{egg} for the force sensor and salmon egg, respectively. Once the sensor is pushed against the egg using the micromanipulation system, the same force, F , is applied to the sensor and egg. Therefore, by using Hooke's law, we have:

$$F = k_{sensor} \cdot \Delta x_{sensor} = k_{egg} \cdot \Delta x_{egg} \quad (1)$$

where Δx_{sensor} and Δx_{egg} are the relative displacement of the sensor and the egg, respectively. By reorganizing the equation, it is possible to solve for the stiffness of the egg, as shown in Eq. 2:

$$k_{egg} = \frac{k_{sensor} \cdot \Delta x_{sensor}}{\Delta x_{egg}} \quad (2)$$

Here, the stiffness of the sensor is known based on its calibration, and the relative displacements are computed using the vision system. Figure 7(a) shows the initial position of the sensor and Fig. 7(b) the system under load. By comparing the distance of the spring markers to the micromanipulator probe body, the overall displacement of the compliant structure can be computed.

Similarly, the position of the egg wall can be compared between the initial and final states to obtain its relative displacement. Using this method described above, the stiffness of the salmon egg was computed to be $20.55 \text{ N/m} \pm 1.92$. This result comes from averaging the computed stiffness at different deflection values after repeatedly performing pushes against the egg outer wall. Furthermore, the sensor was able to puncture the egg's wall and the puncture force recorded to be approximately $725 \mu\text{N}$.

6 Conclusion

In this paper, the design and characterization of the first fully 3D printed vision-based micro-force sensor is presented. The sensor is completely fabricated using 2PP techniques which provides a high resolution, fast, and versatile microfabrication method that is also able to create complex 3D shapes at small scales. These fabricated sensors were characterized and compared to simulations based on the nominal material properties of the photoresin used. It is shown that the printing settings greatly affects the overall stiffness of the fabricated sensor, but the results remain consistent for the same print settings. Furthermore, a bimaterial printing approach was shown to fabricate sensors using a combination of two resins: rigid IP-S for the body and end-effector, and soft IP-PDMS for the sensing spring. This resulted in a sensor with much lower stiffness and therefore much higher force sensing resolution. In order to showcase the capabilities and possible applications of these fully 3D printed sensors, they were utilized to mechanically characterize salmon eggs as cell analogs.

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Declarations

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Author's Contributions: G.A. fabricated and characterized the sensors, and wrote the main manuscript. G.U. fabricated sensors and provided technical expertise and problem solving regarding microfabrication methods and techniques. C.C. and D.C. provided original ideas, and helped supervise the project. All authors provided critical feedback and helped shape the research, analysis, and manuscript.

Availability of Data and Materials: Not Applicable.

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